

# Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic		Symbol	Limit	Unit
Collector-Base Voltage		V <sub>CBO</sub>	-500	
Collector-Emitter Voltage		V <sub>CEO</sub>	-500	V
Emitter-Base Voltage		V <sub>EBO</sub>	-7	
Continuous Collector Current	(Note 4)	Ic	-150	m Λ
Peak Pulse Current		I <sub>CM</sub>	-500	mA mA

### Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
	(Note 4)		2.8 22.4		
Power Dissipation Linear Derating Factor	(Note 5)	P <sub>D</sub>	1.3 10.4	W mW/°C	
	(Note 6)		0.7 5.6		
Thermal Resistance, Junction to Ambient	(Note 4)		45		
	(Note 5)	$R_{\theta JA}$	96	°C/W	
	(Note 6)		179		
Thermal Resistance, Junction to Lead	(Note 7)	$R_{ heta JL}$	14	°C/W	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

Notes:

- 4. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The entire exposed collector pad is attached to the heatsink.

  5. Same as note (4), except the device is mounted on 25mm x 25mm 1oz copper.

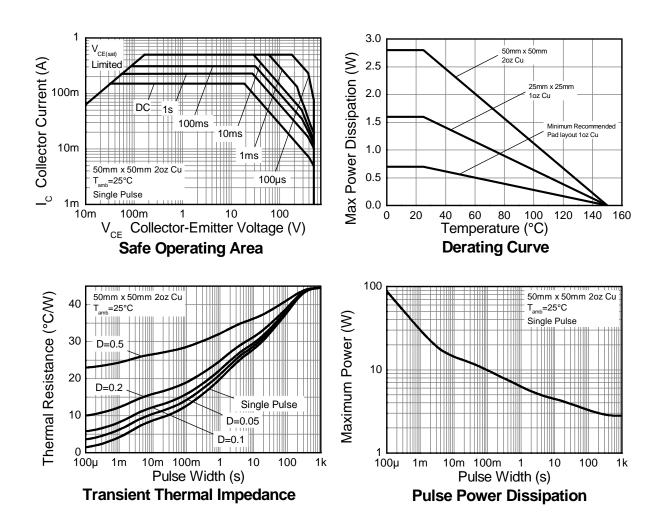
  6. Same as note (4), except the device is mounted on a minimum recommended pad layout of 1oz copper.

- 7. Thermal resistance from junction to solder-point (at the end of the collector lead).





#### **Thermal Characteristics**





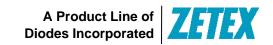


#### Electrical Characteristics @TA = 25°C unless otherwise specified

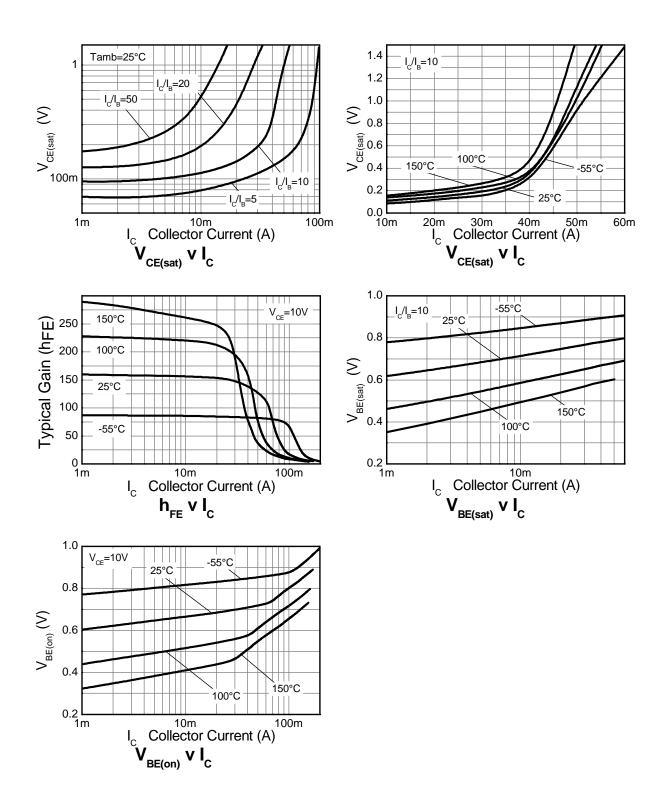
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	$BV_{CBO}$	-500	_	_	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 8)	$BV_{CEO}$	-500	_	_	V	$I_C = -10 \text{mA}$
Emitter-Base Breakdown Voltage	$BV_{EBO}$	-7	_	_	V	$I_E = -100 \mu A$
Collector Cutoff Current	I <sub>CBO</sub>	_	_	-100	nA	V <sub>CB</sub> = -500V
Collector Cutoff Current	I <sub>CES</sub>		_	-100	nA	V <sub>CE</sub> = -500V
Emitter Cutoff Current	I <sub>EBO</sub>	_	_	-100	nA	V <sub>EB</sub> = -5.6V
Collector-Emitter Saturation Voltage (Note 8)	V <sub>CE(sat)</sub>		_	-200 -500	mV	$I_C = -20\text{mA}, I_B = -2\text{mA}$ $I_C = -50\text{mA}, I_B = -10\text{mA}$
Base-Emitter Saturation Voltage (Note 8)	V <sub>BE(sat)</sub>	_	_	-900	mV	I <sub>C</sub> = -50mA, I <sub>B</sub> = -10mA
Base-Emitter Turn-On Voltage (Note 8)	V <sub>BE(on)</sub>	_	_	-900	mV	V <sub>CE</sub> = -10V, I <sub>C</sub> = -50mA
DC Current Gain (Note 8)	h <sub>FE</sub>	100 80 —	— — 15	300 300 —		$V_{CE} = -10V, I_C = -1mA$ $V_{CE} = -10V, I_C = -50mA$ $V_{CE} = -10V, I_C = -100mA$
Transition Frequency	f⊤	60	_	_	MHz	$V_{CE} = -20V, I_{C} = -10mA,$ f = 50MHz
Output Capacitance	C <sub>obo</sub>	_		8	pF	V <sub>CB</sub> = -20V, f = 1MHz
Switching Times	t <sub>on</sub> t <sub>off</sub>		110 1500	_	ns	$V_{CC} = -100V, I_C = -50mA,$ $I_{B1} = 5mA, I_{B2} = -10mA$

Notes: 8. Measured under pulsed conditions. Pulse width  $\leq 300 \mu s$ . Duty cycle  $\leq 2\%$ .





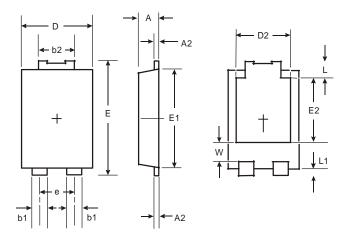
#### **Typical Electrical Characteristics**





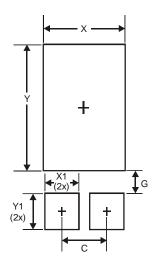


### **Package Outline Dimensions**



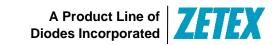
POWERDI <sup>®</sup> 5				
Dim	Min	Max		
Α	1.05	1.15		
A2	0.33	0.43		
b1	0.80	0.99		
b2	1.70	1.88		
D	3.90	4.05		
D2	3.054 Typ			
Е	6.40	6.60		
е	1.84 Typ			
E1	5.30	5.45		
E2	3.549 Typ			
L	0.75	0.95		
L1	0.50	0.65		
W	1.10	1.41		
All Dimensions in mm				

## **Suggested Pad Layout**



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Y	4.860
Y1	1.400





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